



An Overview of Glass-Weave Impact on Millimeter-Wave PCB Performance

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Agenda

- Basic overview of different glass styles and laminate constructions
- Simple definitions of glass-weave effect
- Different circuit-glass configurations where glass weave patterns can impact RF performance
- Overview of recent studies evaluating glass weave effects at millimeter-wave frequencies

An Overview of Glass-Weave Impact on Millimeter-Wave PCB Performance

Basic overview of glass styles and laminate constructions

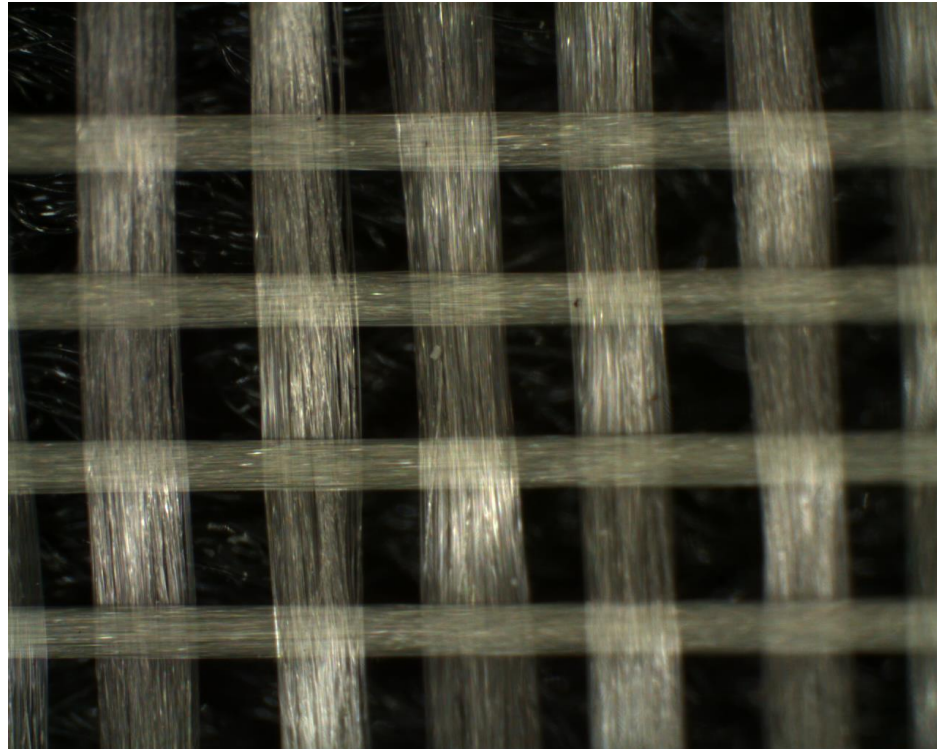
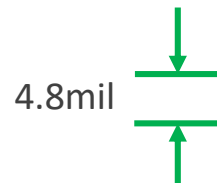
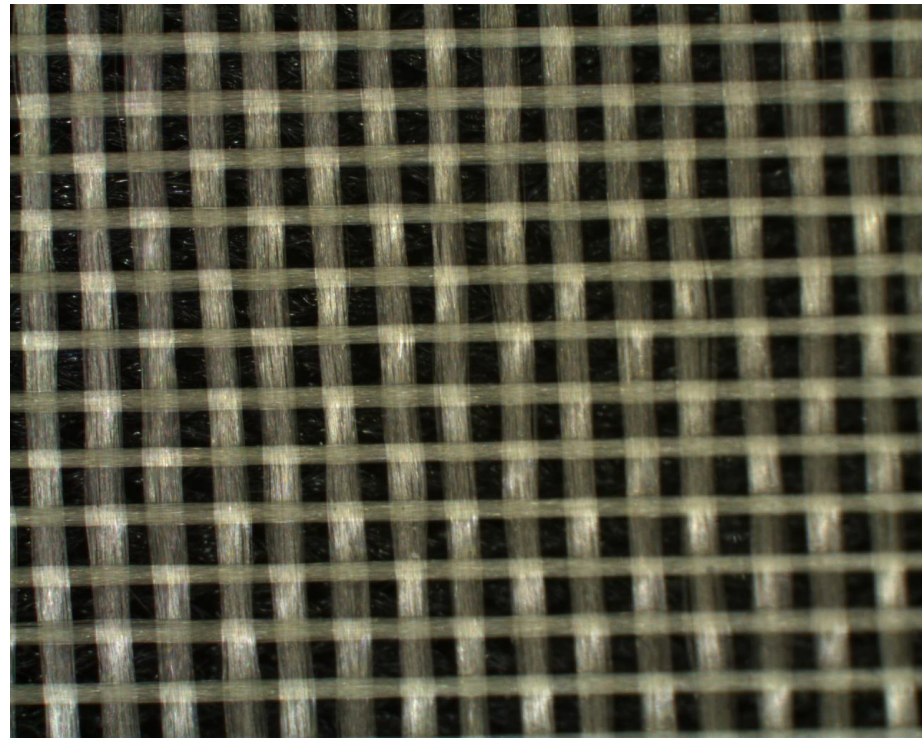
- Over the past several years and in response to the concern of glass-weave effect, there have been different glass fabrics brought to the market to address the issues
- A recent study, with results shown later, will be comparing results from three different types of glass
 - 106, open weave
 - 1080, open weave
 - 1078, spread glass
- All three of these glass styles are relatively thin and are often used in thin laminates made for millimeter-wave applications
- The laminate made with these different glass styles used PTFE only without filler

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Basic overview of glass styles and laminate constructions

- 106 glass, standard weave
- Balanced glass cloth

- Even through the dimensions are different, there is the same amount of glass content on both axes

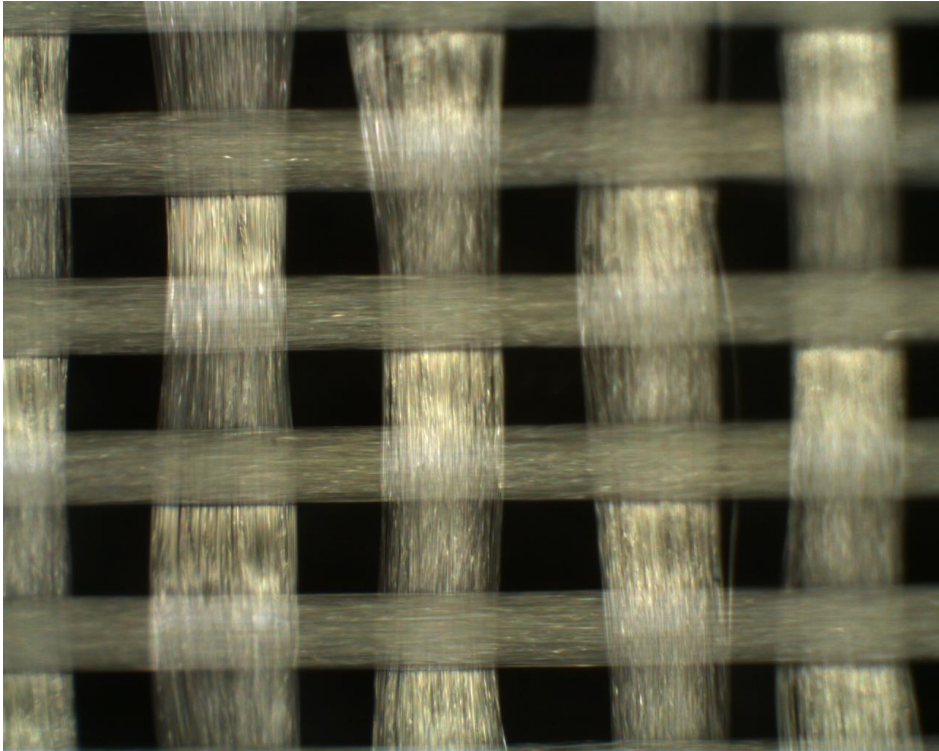
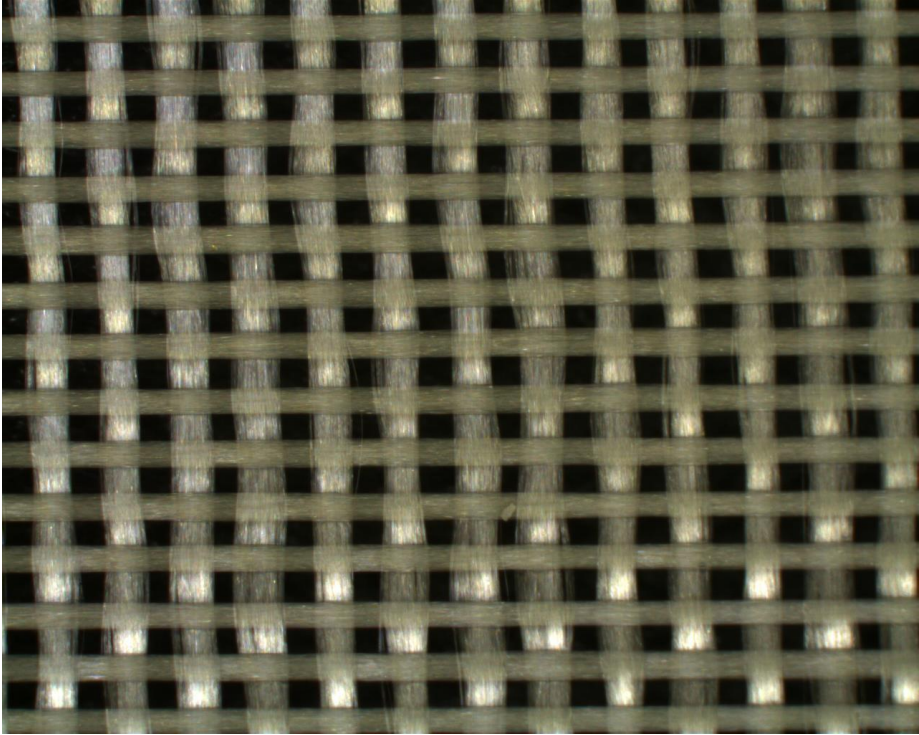
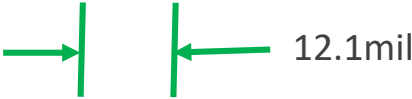


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Basic overview of glass styles and laminate constructions

- 1080 glass, standard weave
- Unbalanced glass cloth

- One axis has more glass content than the other axis

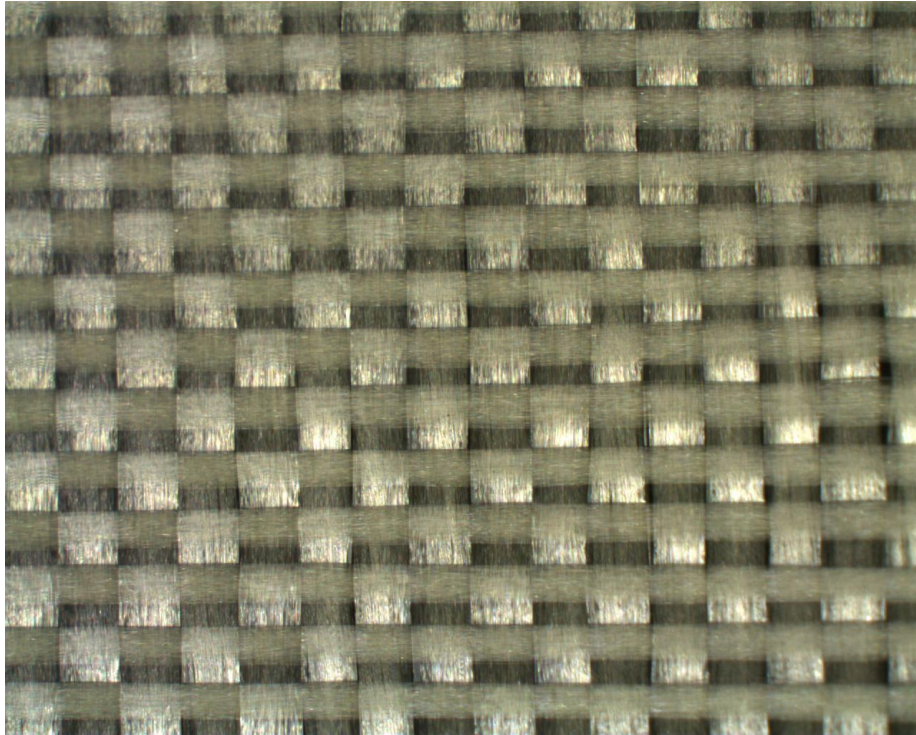


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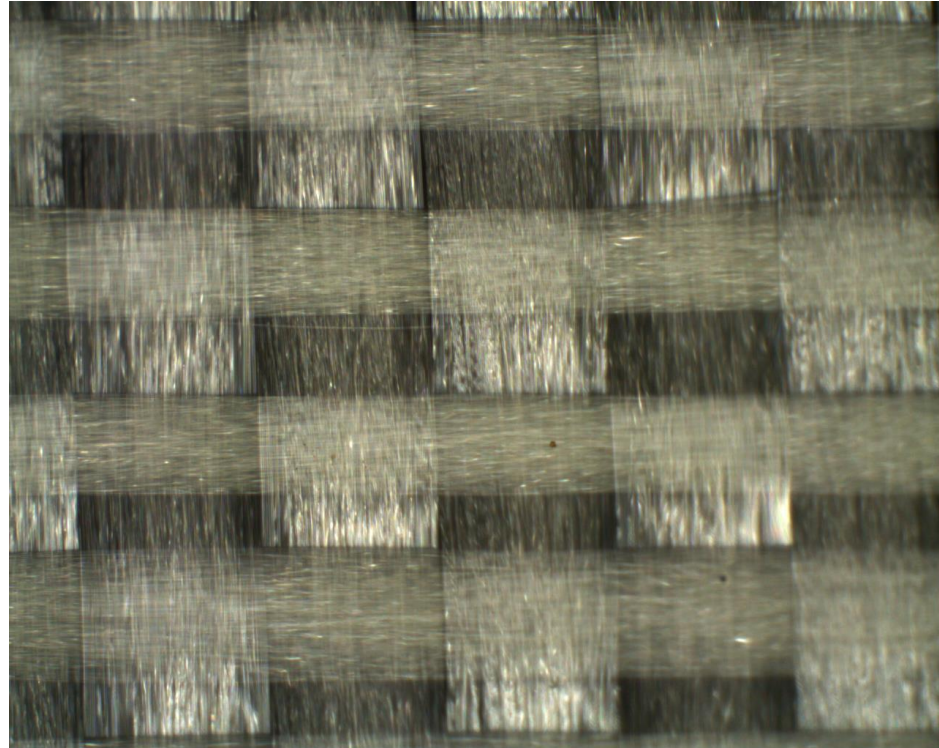
Basic overview of glass styles and laminate constructions

- 1078 glass, spread weave

- This particular glass style is very similar to 1080 glass, but the glass bundles were spread on one axis
- This will behave more like a uniform plane of glass than will standard weave glass styles



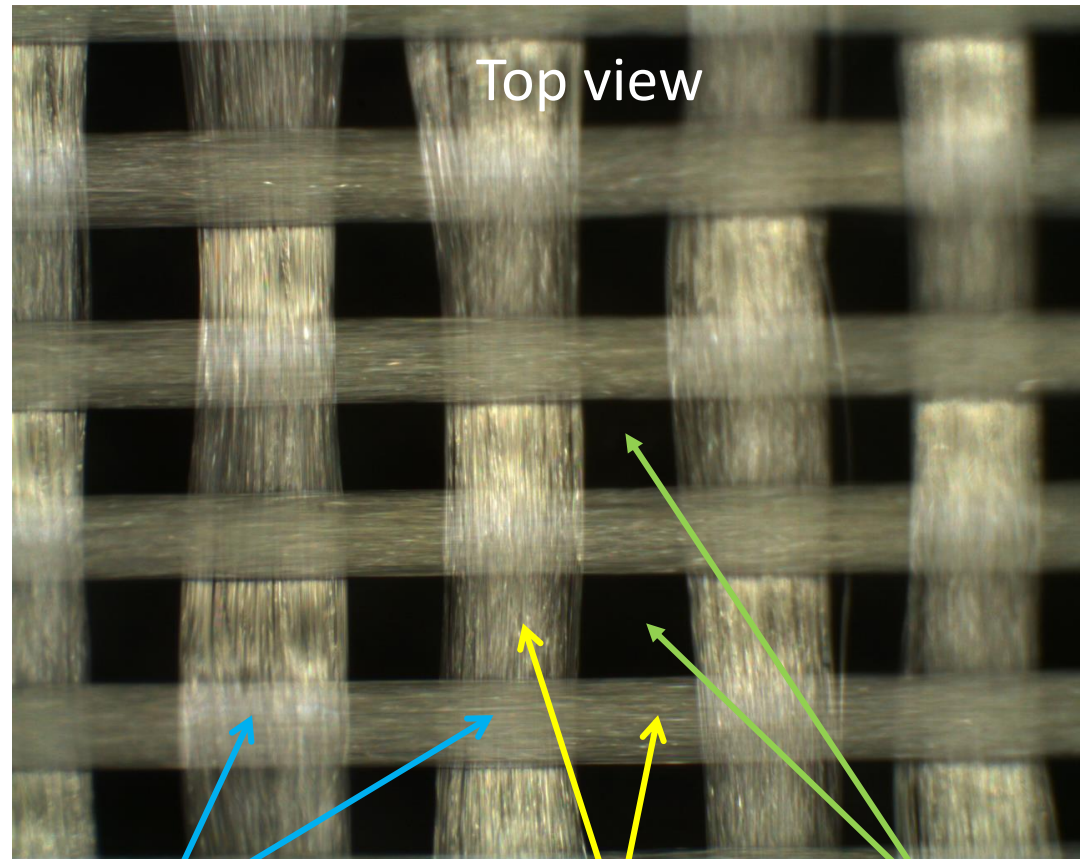
This is considered a balanced glass weave



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Several potential circuit-glass configurations where glass-weave patterns can impact RF performance

- Top view to the right, with no copper planes, assume the resin system is clear, looking down and considering the isolated Dk differences of the different glass-weave configuration
- Glass has a Dk ~ 6
- Resin system can vary a lot, but for mmWave laminates it is usually ~ 2.1 to ~ 3.0



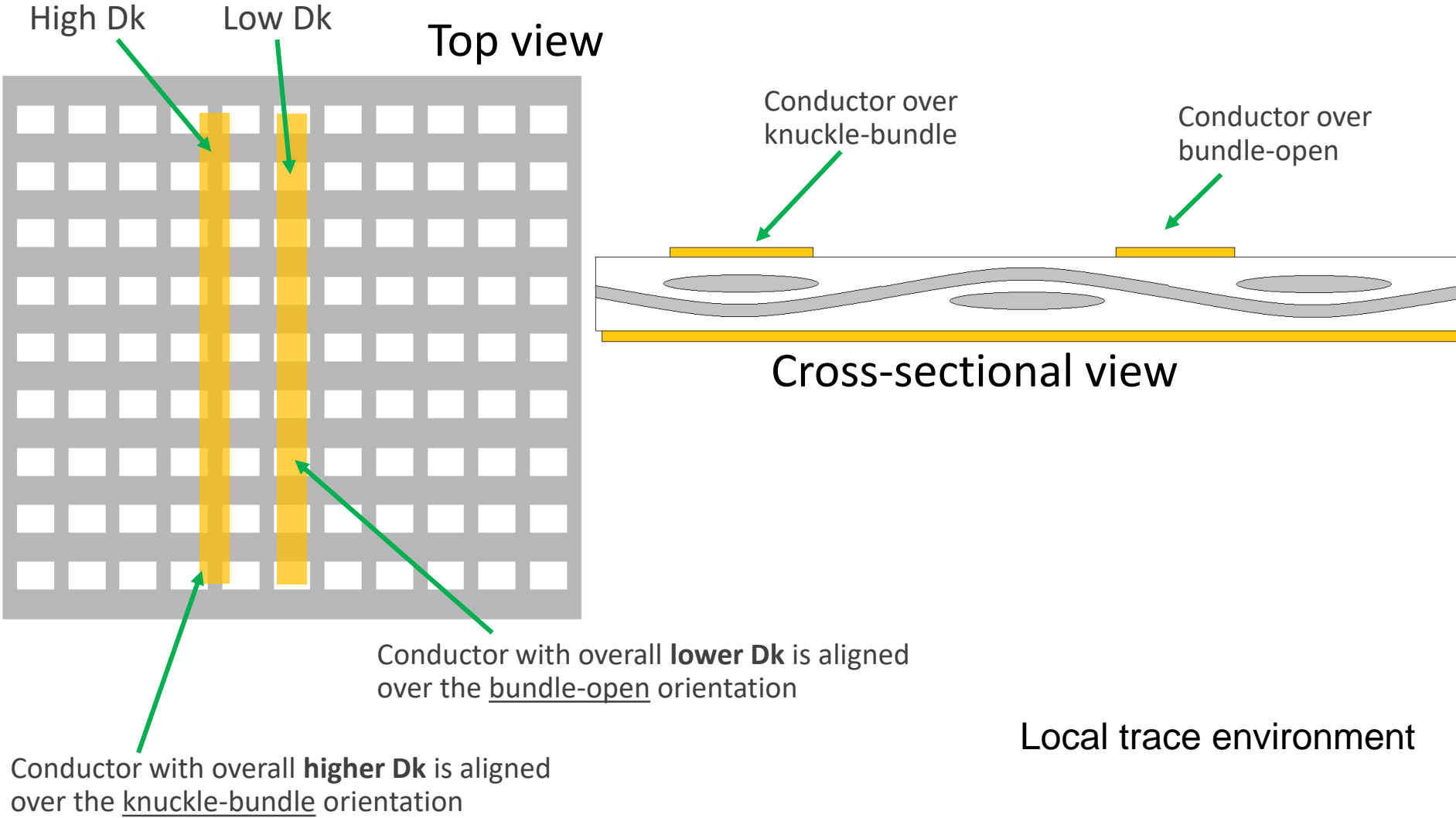
Higher Dk
(glass knuckles)

Lower Dk
(glass bundles)

Lowest Dk
(no glass,
open area)

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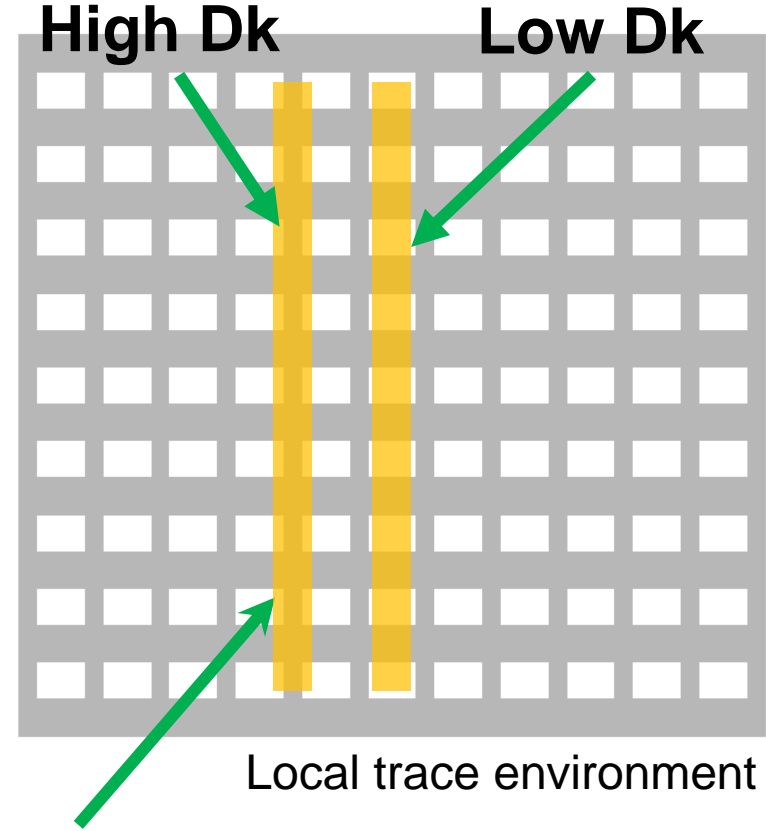
Several potential circuit-glass configurations where glass-weave patterns can impact RF performance



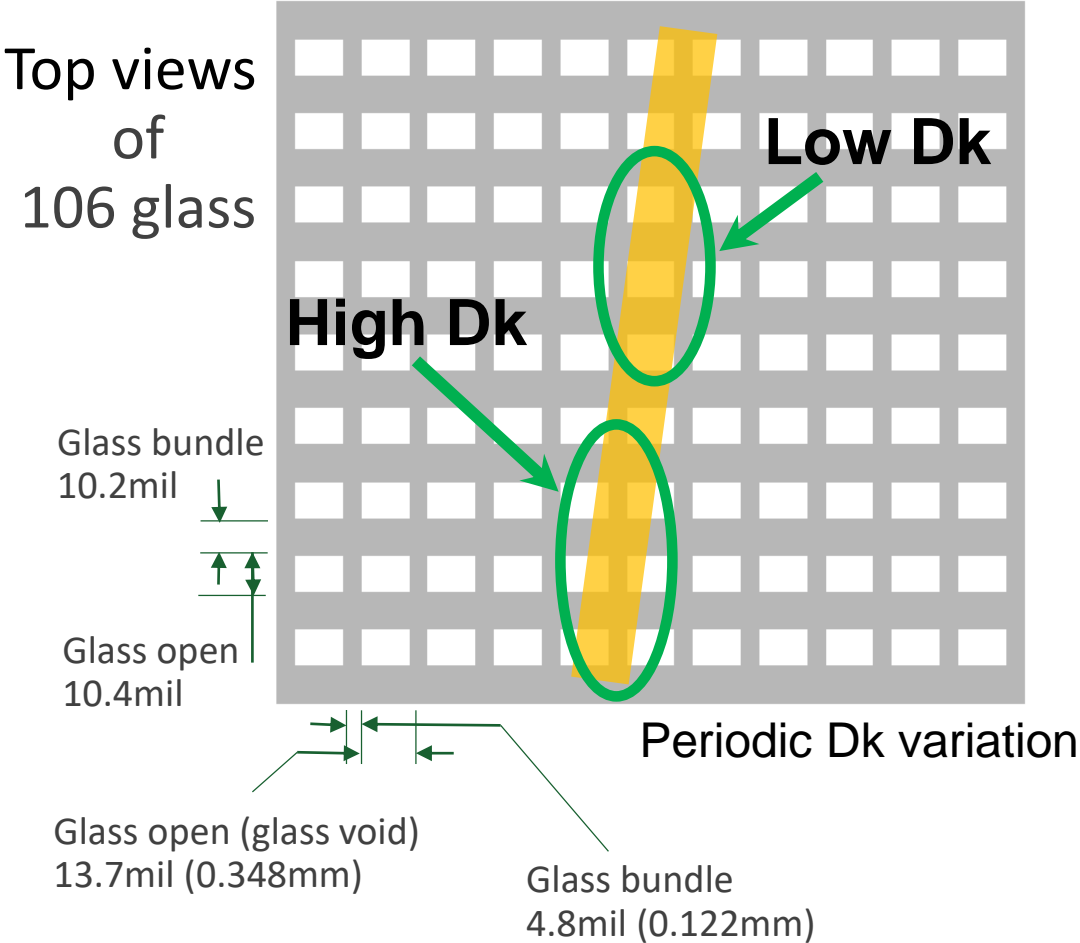
Local trace environment

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Several potential circuit-glass configurations where glass-weave patterns can impact RF performance



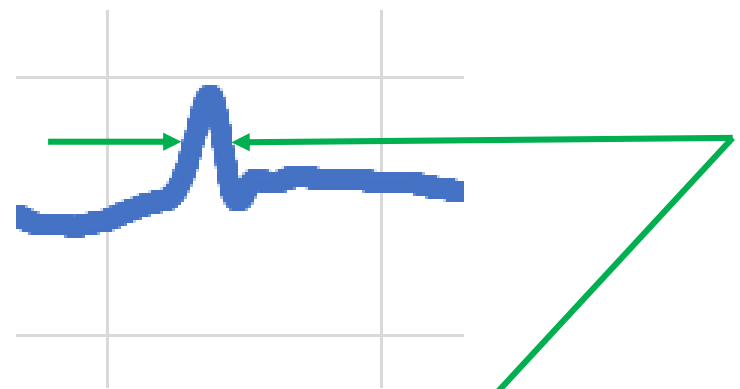
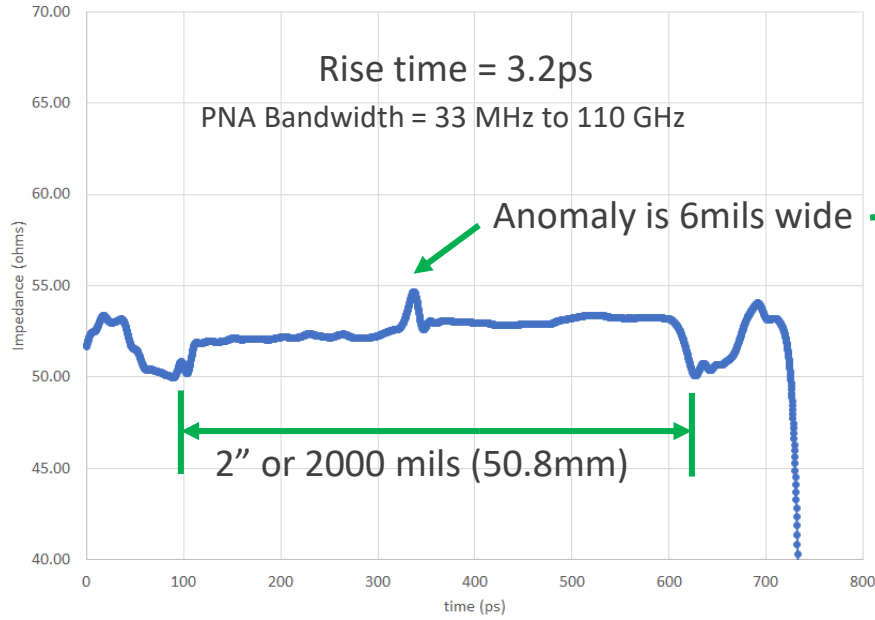
Conductor is aligned on top of glass knuckles and bundles



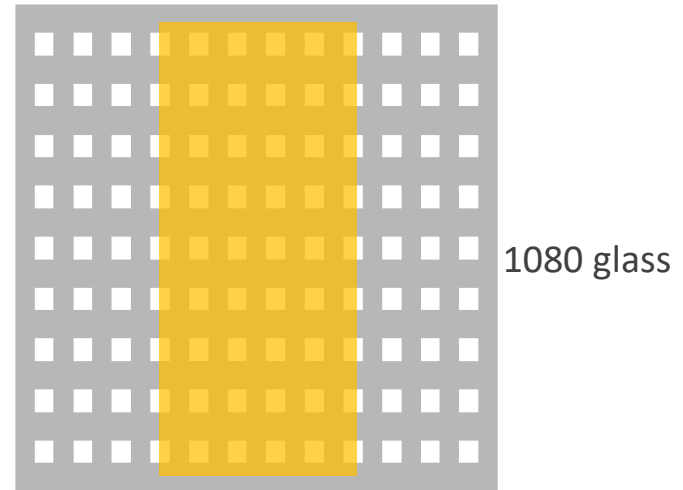
Sometimes periodic variation is due to the glass pattern shifting and not the conductor

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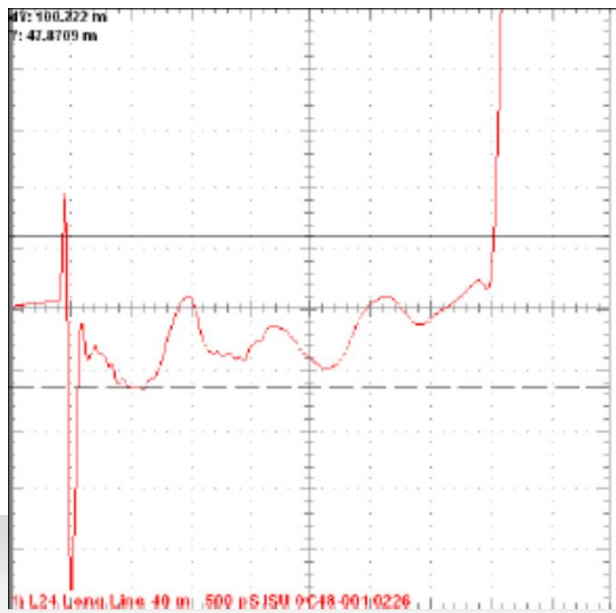
Microstrip impedance of 2" transmission line circuit with notch in middle of conductor using 5mil RO3003G2™ laminate



Middle of peak, measures 13ps wide and that is equivalent to 100mils, which is ~5 x pitch of 1080 glass



It is not possible to see the bundle-open relationship in impedance measurements



← reported to be glass variation on FR-4 with 1080 glass, but on a scale of 500ps (circuit ~ 340ps) there should be about 95 bundle-open areas. This is probably showing a periodic glass-weave effect and not a local effect

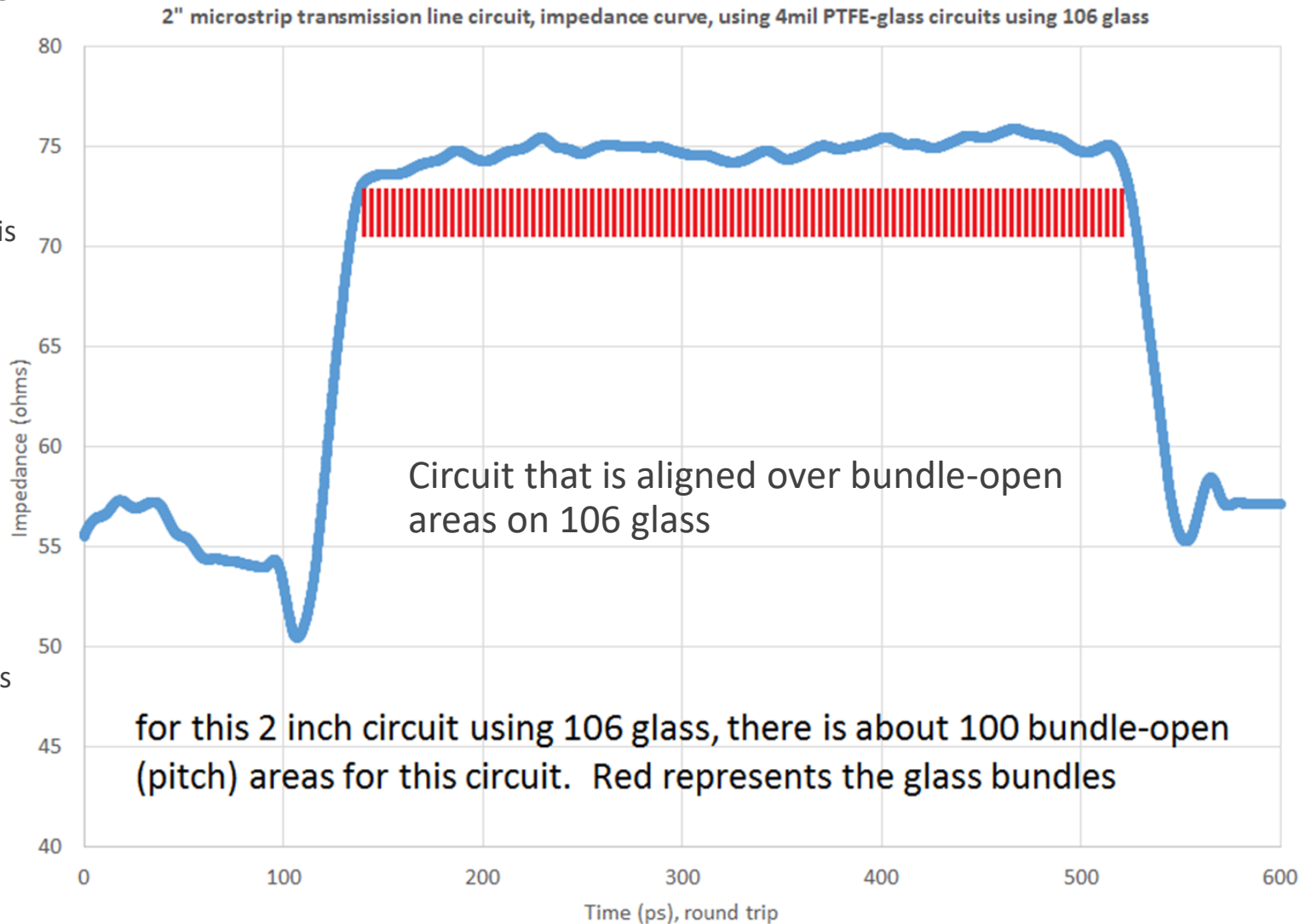
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Impedance curve for one of the circuits in our study

We used a 5mil wide conductor to be more sensitive to the glass-weave pattern and that is why the impedance is higher than 50 ohms

The difference between the resin ($Dk = 2.1$) and the glass ($Dk = 6.0$) is blended together

The bumps on impedance curve is due to periodic glass weave effect and minor conductor width changes along the length of the conductor. A width difference of 0.3mil is 1 ohm impedance difference. This circuit had width variations of 0.5mil along the 2" length

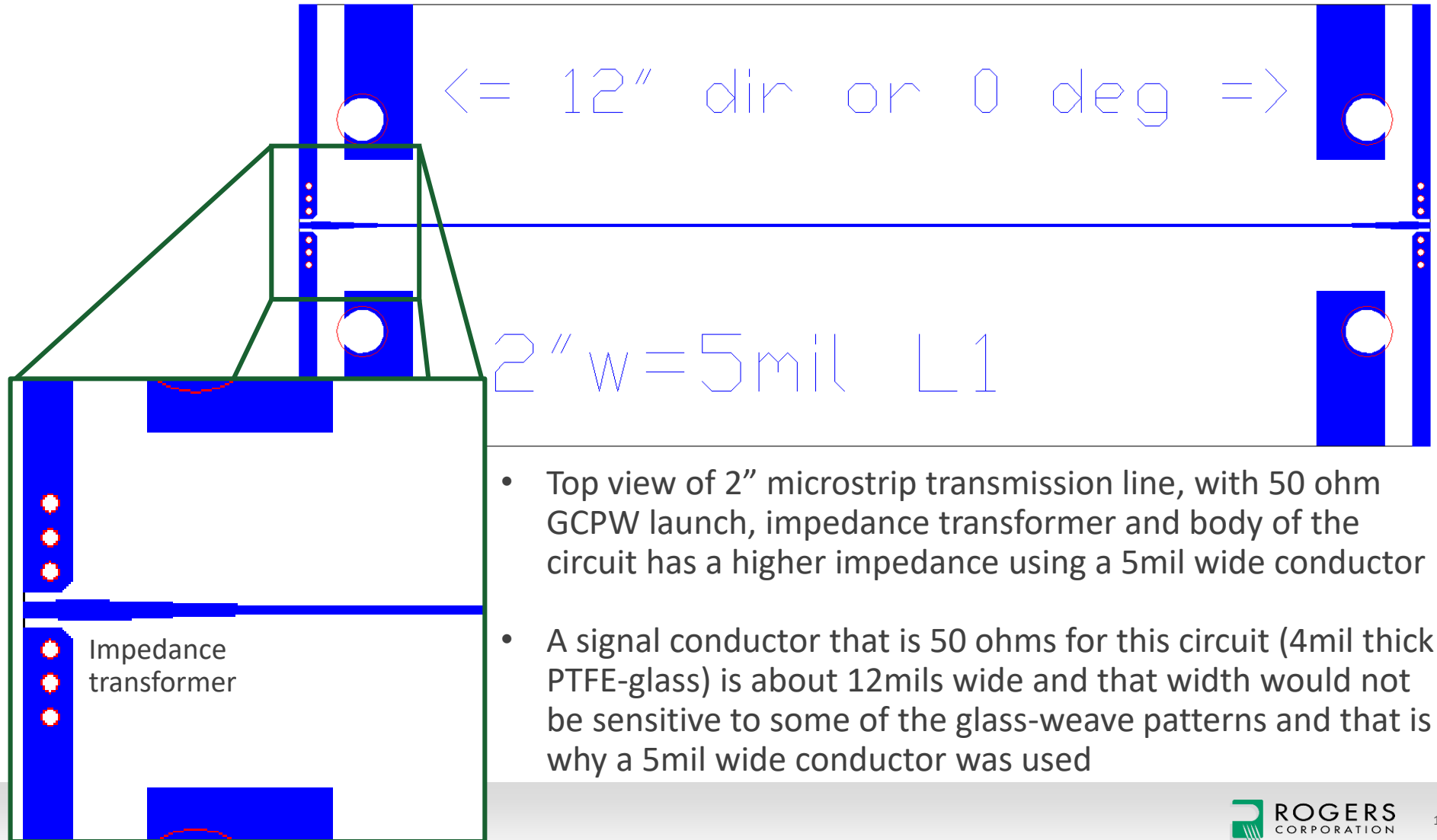


Measured with 3.2ps rise time. Impedance is a round trip measurement

An Overview of Glass-Weave Impact on Millimeter-Wave PCB Performance

Overview of recent studies evaluating glass weave effects at millimeter-wave frequencies

- Test vehicle and test method definition



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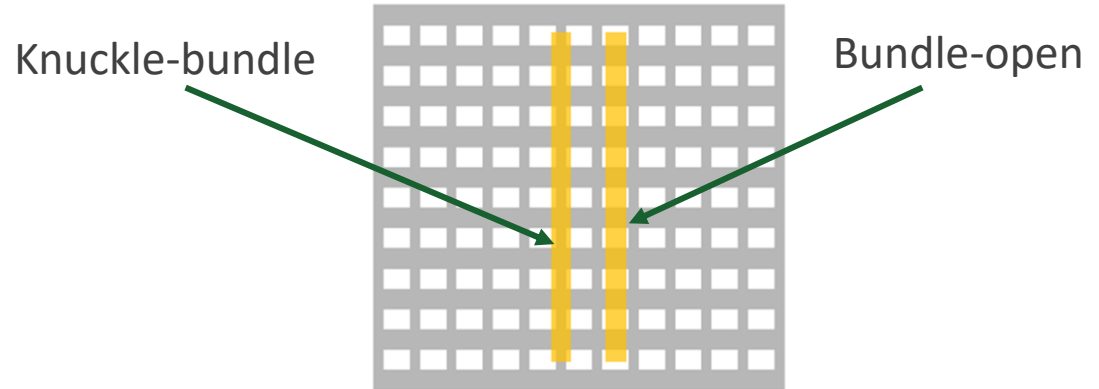
Overview of recent studies evaluating glass weave effects at millimeter-wave frequencies

- Test vehicle and test method definition
 - A network analyzer is designed to measure two properties extremely accurately
 - Magnitude
 - Phase angle
 - For this evaluation, the following properties were measured:
 - Phase angle (unwrapped)
 - Group delay (based on phase angle which varies with frequency)
 - Propagation delay, from effective D_k measurements based on phase angle
 - Impedance from reflected S11 and S22
 - Comparisons of these properties were done with circuits using:
 - 4mil thick PTFE-woven-glass with 106 glass
 - 4mil thick PTFE-woven-glass with 1080 glass
 - 4mil thick PTFE-woven-glass with 1078 glass
 - 4mil thick RO4835™ LoPro® laminate with 1080 glass

An Overview of Glass-Weave Impact on Millimeter-Wave PCB Performance

Overview of recent studies evaluating glass weave effects at millimeter-wave frequencies

- Overview of test results



Average differences between knuckle-bundle and bundle-open

Glass style	Type	40 GHz to 80 GHz			77 GHz phase angle (°)
		group delay (ps)	Prop delay (ps)		
		106	open weave, balanced	4.7	6.9
1078	spread, balanced	1	1.3	20	
1080	open weave, unbalanced	7.3	10.1	149	

Equivalent difference in Dk (ΔDk) between knuckle-bundle and bundle-open

Glass style	Type	40 GHz to 80 GHz		77 GHz ΔDk from phase angle
		ΔDk from group delay	ΔDk from propagation delay	
		106	open weave, balanced	0.11
1078	spread, balanced	0.02	0.03	0.02
1080	open weave, unbalanced	0.17	0.22	0.14

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